NOTES (UNLESS OTHERWISE SPECIFIED):

- 1) RICD-FLEX PORTION IS 6 LAYER
 2) FLEX PORTION IS 4 LAYER
 3) NO SOLDER MASK OR OVERLAY LAYERS
- 5) THE PHOTO TOOL SHALL NOT BE COMPENSATED WITHOUT PRIOR ENGNEETING APPROVAL PCB DESIGNER: RICH LOBDILL PH (805) 305-1393 FAX (805) 961-1792.

FABRICATION TOLERANCES

26.00-

- 6) END PRODUCT CONDUCTOR WIDTHS AND PAD DIAMETERS SHALL NOT VARY MORE THAN 0.002" FROM THE 1:1 DMENSIONS OF THE MASTER ARTWORK.

 7) THE CONDUCTIVE PATTERN SHALL BE POSTIONED SO THAT THE LOCATION OF ANY PAD OR LAND SHALL BE WITHN 0.005" DIAMETER TO THE TRUE POSTION OF THE HOLE IT CRCUMSCRBES.

 8) ALL DRAL HOLE SZES AND TOLERANCES APPLY AFTER PLATING.

 9) THE MINIMUM ANNULLAR RING SHALL BE 0.005".

 10) BOW AND TWIST SHALL NOT EXCEED 0.010" PER NCH.

 11) FOR PCB ROUTING DMENSIONS: XXX = +/-.055" XX = +/-.020"

MATERIAL

12) RIGID SECTIONS
BASE LAMINATE: ARLON 85N (DO NOT USE 85N PRE-PREG)
PRE-PREG: ARLON 38N

13) FLEX SECTIONS
FLEX LAMINATE: DUPONT PYRALUX AP9111
ADHESIVE: DUPONT PYRALUX LF0200

PLATING

14) ALL HOLES AND CONDUCTIVE SURFACES SHALL BE PLATED WITH A MINIMUM OF 0.001" COPPER.

15) ALL EXPOSED HOLES AND CONDUCTIVE SURFACES SHALL BE COATED

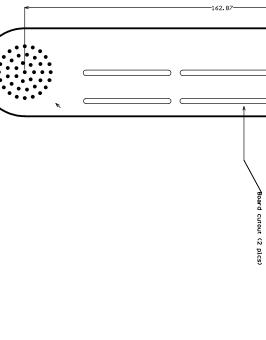
WITH A GOLD MMERSION PLATING TO PRESERVE SOLDERABILITY.

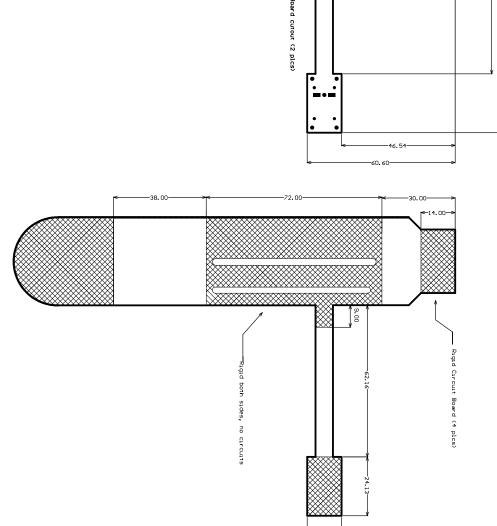
COATINGS 16) NO SOLDERMASK

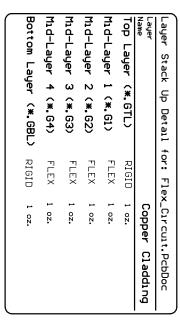
MARKING 18) NO SIKSCREEN 19)

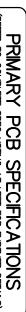
20)

ELECTRICAL TESTING
21) ALL BOARDS SHALL BE ELECTRICALLY TESTED TO THE SUPPLED IPC-D-356A NET LIST FOR CONTINUITY, OPENS AND SHORTS.









PRIMARY PCB SPECIFICATIONS

(REFER TO COMPLETE SPEC LISTING AT LEFT FOR FURTHER DETALS)

NUMBER OF LAYERS — 6
FINISHED THICKNESS — .062"
BASE MATERIAL — SEE NOTES ABOVE PLATING TYPE — GOLD IMMERSION

SOLDER MASK COLOR — NO SOLDER MASK

